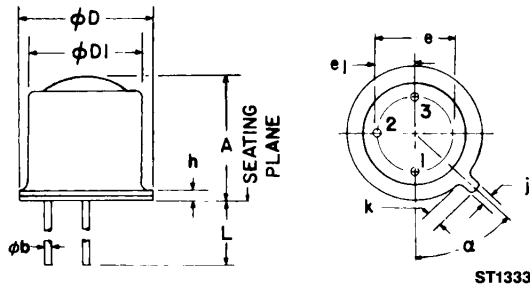




## HERMETIC SILICON PHOTOTRANSISTOR

### L14G1/2/3

#### PACKAGE DIMENSIONS



ST1333

#### DESCRIPTION

The L14G series is a silicon phototransistor mounted in a narrow angle, TO-18 package.

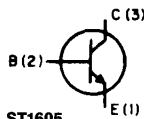
#### FEATURES

- Hermetically sealed package
- Narrow reception angle

SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	.225	.255	5.71	6.47	
@b	.016	.021	.407	.533	
@D	.209	.230	5.31	5.84	
@D <sub>1</sub>	.178	.195	4.52	4.96	
e	.100 NOM		2.54 NOM		2
e <sub>1</sub>	.050 NOM		1.27 NOM		2
h	—	.030	—	.76	
j	.036	.046	.92	1.16	
k	.028	.048	.71	1.22	1
L	.500	—	12.7	—	
$\alpha$	45°	45°	45°	45°	3

#### PACKAGE OUTLINE

(COLLECTOR  
CONNECTED  
TO CASE)



ST1605

#### NOTES:

1. MEASURED FROM MAXIMUM DIAMETER OF DEVICE.
2. LEADS HAVING MAXIMUM DIAMETER .021" (.533mm) MEASURED IN GAUGING PLANE .054" + .001" - .000 (137 + .025 - .000mm) BELOW THE REFERENCE PLANE OF THE DEVICE SHALL BE WITHIN .007" (.778mm) THEIR TRUE POSITION RELATIVE TO MAXIMUM WIDTH TAB.
3. FROM CENTERLINE TAB.



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PHOTOTRANSISTOR**

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A = 25^\circ\text{C}$ Unless Otherwise Specified)	
Storage Temperature .....	$-65^\circ\text{C}$ to $+150^\circ\text{C}$
Operating Temperature .....	$-65^\circ\text{C}$ to $+125^\circ\text{C}$
Soldering:	
Lead Temperature (Iron) .....	$240^\circ\text{C}$ for 5 sec. <sup>(3,4,5,6)</sup>
Lead Temperature (Flow) .....	$260^\circ\text{C}$ for 10 sec. <sup>(3,4,6)</sup>
Collector-Emitter Breakdown Voltage .....	45 Volts
Collector-Base Breakdown Voltage .....	45 Volts
Emitter-Base Breakdown Voltage .....	5 Volts
Power Dissipation ( $T_A = 25^\circ\text{C}$ ) .....	300 mW <sup>(1)</sup>
Power Dissipation ( $T_C = 25^\circ\text{C}$ ) .....	600 mW <sup>(2)</sup>

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25^\circ\text{C}$ Unless Otherwise Specified) (All measurements made under pulse conditions.)						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
Collector-Emitter Breakdown	$BV_{CEO}$	45	—	—	V	$I_C = 10\text{ mA}$ , $E_e = 0$
Emitter-Base Breakdown	$BV_{EBO}$	5.0	—	—	V	$I_E = 100\ \mu\text{A}$ , $E_e = 0$
Collector-Base Breakdown	$BV_{CBO}$	45	—	—	V	$I_C = 100\ \mu\text{A}$ , $E_e = 0$
Collector-Emitter Leakage	$I_{CEO}$	—	—	100	nA	$V_{CE} = 10\text{ V}$ , $E_e = 0$
Reception Angle at 1/2 Sensitivity	$\theta$	—	$\pm 10$	—	Degrees	
On-State Collector Current L14G1	$I_{C(ON)}$	6.0	—	—	mA	$E_e = 3.0\text{ mW/cm}^2$ , $V_{CE} = 5\text{ V}^{(7,8)}$
On-State Collector Current L14G2	$I_{C(ON)}$	3.0	—	—	mA	$E_e = 3.0\text{ mW/cm}^2$ , $V_{CE} = 5\text{ V}^{(7,8)}$
On-State Collector Current L14G3	$I_{C(ON)}$	12.0	—	—	mA	$E_e = 3.0\text{ mW/cm}^2$ , $V_{CE} = 5\text{ V}^{(7,8)}$
Turn-On Time	$t_{on}$	—	8	—	$\mu\text{S}$	$I_C = 2\text{ mA}$ , $V_{CC} = 10\text{ V}$ , $R_L = 100\ \Omega$
Turn-Off Time	$t_{off}$	—	7	—	$\mu\text{S}$	$I_C = 2\text{ mA}$ , $V_{CC} = 10\text{ V}$ , $R_L = 100\ \Omega$
Saturation Voltage	$V_{CE(SAT)}$	—	—	0.40	V	$I_C = 1.0\text{ mA}$ , $E_e = 3.0\text{ mW/cm}^{2(7,8)}$

<b>NOTES</b>
<ol style="list-style-type: none"> <li>1. Derate power dissipation linearly 3.00mW/°C above 25°C ambient.</li> <li>2. Derate power dissipation linearly 6.00mW/°C above 25°C case.</li> <li>3. RMA flux is recommended.</li> <li>4. Methanol or Isopropyl alcohols are recommended as cleaning agents.</li> <li>5. Soldering iron tip 1/16" (1.6 mm) minimum from housing.</li> <li>6. As long as leads are not under any stress or spring tension.</li> <li>7. Light source is a GaAs LED emitting light at a peak wavelength of 940 nm.</li> <li>8. Figure 1 and figure 2 use light source of tungsten lamp at 2870°K color temperature. A GaAs source of 3.0 mW/cm² is approximately equivalent to a tungsten source, at 2870°K of 10 mW/cm².</li> </ol>



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